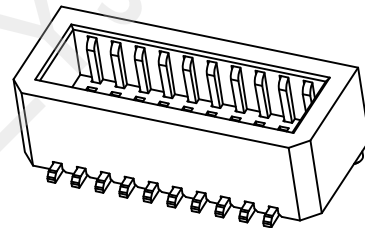


RFCOMMFND P.C.BOARD LAYOUT



Specifications

Current Rating: 0.5Amp  
 Insulation Resistance: 1000MΩ Min.  
 Dielectric Withstanding: 300V AC  
 Contact Resistance: 20mΩ Max.  
 Operating Temperature: -40°C to +105°

Materials

Contact Material: Phosphor Bronze  
 Insulation Material: High Temperature Thermoplastic, UL 94V-0 (Nylon 9T) or the equivalent material

合高	H
4.00H	2.90
4.50H	
5.00H	
5.50H	3.40
6.00H	
6.50H	3.90
7.00H	

Circuits	排列	Dimensions(mm)			
		A	B	C	D
6	2*3	4.30	2.80	1.60	3.40
8	2*4	5.10	3.60	2.40	4.20
10	2*5	5.90	4.40	3.20	5.00
12	2*6	6.70	5.20	4.00	5.80
14	2*7	7.50	6.00	4.80	6.60
16	2*8	8.30	6.80	5.60	7.40
18	2*9	9.10	7.60	6.40	8.20
20	2*10	9.90	8.40	7.20	9.00
30	2*15	13.90	12.40	11.20	13.00
40	2*20	17.90	16.40	15.20	17.00
50	2*25	21.90	20.40	19.20	21.00



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.8PH 单槽BTB 母座	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC36F-BTB2XN-XXX	MOLD NO.
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2304171138	SHEET NO. 1 OF 1